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Embedded microprocessors are specialized computing chips designed to perform specific tasks within an embedded system. Unlike general-purpose microprocessors found in personal computers, embedded microprocessors are tailored for dedicated functions within larger systems, offering optimized performance, efficiency, and reliability. These microprocessors are integral to the operation of countless electronic devices, providing the computational power necessary for controlling processes, handling data, and managing communications.

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Embedded microprocessors are utilized across a broad spectrum of applications, making them indispensable in

Details

Product Status	Obsolete
Core Processor	PowerPC G2_LE
Number of Cores/Bus Width	1 Core, 32-Bit
Speed	266MHz
Co-Processors/DSP	Communications; RISC CPM, Security; SEC
RAM Controllers	DRAM, SDRAM
Graphics Acceleration	No
Display & Interface Controllers	-
Ethernet	10/100Mbps (2)
SATA	-
USB	USB 2.0 (1)
Voltage - I/O	3.3V
Operating Temperature	-40°C ~ 105°C (TA)
Security Features	Cryptography, Random Number Generator
Package / Case	516-BBGA
Supplier Device Package	516-PBGA (27x27)
Purchase URL	https://www.e-xfl.com/product-detail/nxp-semiconductors/mpc8272czqmiba

1 Overview

This table shows the functionality supported by each SoC in the MPC8272 family.

Table 1. MPC8272 PowerQUICC II Family Functionality

Functionality	Package ¹	SoCs			
		MPC8272	MPC8248	MPC8271	MPC8247
		516 PBGA			
Serial communications controllers (SCCs)		3	3	3	3
QUICC multi-channel controller (QMC)		Yes	Yes	Yes	Yes
Fast communication controllers (FCCs)		2	2	2	2
I-Cache (Kbyte)		16	16	16	16
D-Cache (Kbyte)		16	16	16	16
Ethernet (10/100)		2	2	2	2
UTOPIA II Ports		1	0	1	0
Multi-channel controllers (MCCs)		0	0	0	0
PCI bridge		Yes	Yes	Yes	Yes
Transmission convergence (TC) layer		—	—	—	—
Inverse multiplexing for ATM (IMA)		—	—	—	—
Universal serial bus (USB) 2.0 full/low rate		1	1	1	1
Security engine (SEC)		Yes	Yes	—	—

¹ See [Table 2](#).

Devices in the MPC8272 family are available in two packages—the VR or ZQ package—as shown in . For package ordering information, see [Section 10, “Ordering Information.”](#)

Table 2. MPC8272 PowerQUICC II Device Packages

Code (Package)	VR (516 PBGA—Lead free)	ZQ (516 PBGA—Lead spheres)
Device	MPC8272VR	MPC8272ZQ
	MPC8248VR	MPC8248ZQ
	MPC8271VR	MPC8271ZQ
	MPC8247VR	MPC8247ZQ

- PCI bridge
 - PCI Specification revision 2.2-compliant and supports frequencies up to 66 MHz
 - On-chip arbitration
 - Support for PCI to 60x memory and 60x memory to PCI streaming
 - PCI host bridge or peripheral capabilities
 - Includes four DMA channels for the following transfers:
 - PCI-to-60x to 60x-to-PCI
 - 60x-to-PCI to PCI-to-60x
 - PCI-to-60x to PCI-to-60x
 - 60x-to-PCI to 60x-to-PCI
 - Includes the configuration registers required by the PCI standard (which are automatically loaded from the EPROM to configure the MPC8272) and message and doorbell registers
 - Supports the I₂O standard
 - Hot-Swap friendly (supports the Hot Swap Specification as defined by PICMG 2.1 R1.0 August 3, 1998)
 - Support for 66 MHz, 3.3 V specification
 - 60x-PCI bus core logic, which uses a buffer pool to allocate buffers for each port

2 Operating Conditions

This table shows the maximum electrical ratings.

Table 3. Absolute Maximum Ratings¹

Rating	Symbol	Value	Unit
Core supply voltage ²	VDD	–0.3 – 2.25	V
PLL supply voltage ²	VCCSYN	–0.3 – 2.25	V
I/O supply voltage ³	VDDH	–0.3 – 4.0	V
Input voltage ⁴	VIN	GND(–0.3) – 3.6	V
Junction temperature	T _j	120	°C
Storage temperature range	T _{STG}	(–55) – (+150)	°C

¹ Absolute maximum ratings are stress ratings only; functional operation (see [Table 4](#)) at the maximums is not guaranteed. Stress beyond those listed may affect device reliability or cause permanent damage.

² **Caution:** VDD/VCCSYN must not exceed VDDH by more than 0.4 V during normal operation. It is recommended that VDD/VCCSYN should be raised before or simultaneous with VDDH during power-on reset. VDD/VCCSYN may exceed VDDH by more than 0.4 V during power-on reset for no more than 100 ms.

³ **Caution:** VDDH can exceed VDD/VCCSYN by 3.3 V during power on reset by no more than 100 mSec. VDDH should not exceed VDD/VCCSYN by more than 2.5 V during normal operation.

⁴ **Caution:** VIN must not exceed VDDH by more than 2.5 V at any time, including during power-on reset.

3 DC Electrical Characteristics

This table shows DC electrical characteristics.

Table 5. DC Electrical Characteristics¹

Characteristic	Symbol	Min	Max	Unit
Input high voltage—all inputs except TCK, $\overline{\text{TRST}}$ and $\overline{\text{PORESET}}$ ²	V_{IH}	2.0	3.465	V
Input low voltage ³	V_{IL}	GND	0.8	V
CLKIN input high voltage	V_{IHC}	2.4	3.465	V
CLKIN input low voltage	V_{ILC}	GND	0.4	V
Input leakage current, $V_{IN} = V_{DDH}$ ⁴	I_{IN}	—	10	μA
Hi-Z (off state) leakage current, $V_{IN} = V_{DDH}$ ²	I_{OZ}	—	10	μA
Signal low input current, $V_{IL} = 0.8 \text{ V}$	I_L	—	1	μA
Signal high input current, $V_{IH} = 2.0 \text{ V}$	I_H	—	1	μA
Output high voltage, $I_{OH} = -2 \text{ mA}$ except UTOPIA mode, and open drain pins In UTOPIA mode ⁵ (UTOPIA pins only): $I_{OH} = -8.0 \text{ mA}$ PA[8–31] PB[18–31] PC[0–1,4–29] PD[7–25, 29–31]	V_{OH}	2.4	—	V
In UTOPIA mode ⁵ (UTOPIA pins only): $I_{OL} = 8.0 \text{ mA}$ PA[8–31] PB[18–31] PC[0–1,4–29] PD[7–25, 29–31]	V_{OL}	—	0.5	V

Table 5. DC Electrical Characteristics¹ (continued)

Characteristic	Symbol	Min	Max	Unit
$I_{OL} = 6.0\text{mA}$ $\overline{BR}$ $\overline{BG}/\overline{IRQ6}$ $\overline{ABB}/\overline{IRQ2}$ $\overline{TS}$ $A[0-31]$ $TT[0-4]$ $\overline{TBST}$ $TSIZE[0-3]$ $\overline{AACK}$ $\overline{ARTRY}$ $\overline{DBG}/\overline{IRQ7}$ $\overline{DBB}/\overline{IRQ3}$ $D[0-63]$ $\overline{IRQ3}/\overline{CKSTP_OUT}/\overline{EXT_BR3}$ $\overline{IRQ4}/\overline{CORE_SRESET}/\overline{EXT_BG3}$ $\overline{IRQ5}/\overline{TBEN}/\overline{EXT_DBG3}/\overline{CINT}$ $\overline{PSDVAL}$ $\overline{TA}$ $\overline{TEA}$ $\overline{GBL}/\overline{IRQ1}$ $\overline{CI}/\overline{BADDR29}/\overline{IRQ2}$ $\overline{WT}/\overline{BADDR30}/\overline{IRQ3}$ $\overline{BADDR31}/\overline{IRQ5}/\overline{CINT}$ $\overline{CPU_BR}/\overline{INT_OUT}$ $\overline{IRQ0}/\overline{NMI_OUT}$ $\overline{PORESET}/\overline{PCI_RST}$ $\overline{HRESET}$ $\overline{SRESET}$ $\overline{RSTCONF}$	V_{OL}	—	0.4	V

DC Electrical Characteristics

⁵ MPC8272 and MPC8271 only.

Table 6.

Characteristic	Symbol	Min	Max	Unit
Input high voltage—all inputs except TCK, $\overline{\text{TRST}}$ and $\overline{\text{PORESET}}^1$	V_{IH}	2.0	3.465	V
Input low voltage	V_{IL}	GND	0.8	V
CLKIN input high voltage	V_{IHC}	2.4	3.465	V
CLKIN input low voltage	V_{ILC}	GND	0.4	V
Input leakage current, $V_{IN} = V_{DDH}^2$	I_{IN}	—	10	μA
Hi-Z (off state) leakage current, $V_{IN} = V_{DDH}^2$	I_{OZ}	—	10	μA
Signal low input current, $V_{IL} = 0.8 \text{ V}^3$	I_L	—	1	μA
Signal high input current, $V_{IH} = 2.0 \text{ V}$	I_H	—	1	μA
Output high voltage, $I_{OH} = -2 \text{ mA}$ except UTOPIA mode, and open drain pins In UTOPIA mode ⁴ (UTOPIA pins only): $I_{OH} = -8.0 \text{ mA}$	V_{OH}	2.4	—	V
In UTOPIA mode ⁴ (UTOPIA pins only): $I_{OL} = 8.0 \text{ mA}$	V_{OL}	—	0.5	V
$I_{OL} = 6.0 \text{ mA}$ $\overline{\text{BR}}$ $\overline{\text{BG}}$ $\overline{\text{ABB/IRQ2}}$ $\overline{\text{TS}}$ A[0-31] TT[0-4] $\overline{\text{TBST}}$ TSIZE[0-3] $\overline{\text{AACK}}$ $\overline{\text{ARTRY}}$ $\overline{\text{DBG}}$ $\overline{\text{DBB/IRQ3}}$ D[0-63] $\overline{\text{//EXT_BR3}}$ $\overline{\text{//EXT_BG3}}$ $\overline{\text{//TBEN/EXT_DBG3/CINT}}$ $\overline{\text{PSDVAL}}$ $\overline{\text{TA}}$ $\overline{\text{TEA}}$ $\overline{\text{GBL/IRQ1}}$ $\overline{\text{CI/BADDR29/IRQ2}}$ $\overline{\text{WT/BADDR30/IRQ3}}$ $\overline{\text{BADDR31/IRQ5/CINT}}$ $\overline{\text{CPU_BR}}$ $\overline{\text{IRQ0/NMI_OUT}}$ $\overline{\text{//PCI_RST}}$ $\overline{\text{HRESET}}$ $\overline{\text{SRESET}}$ $\overline{\text{RSTCONF}}$	V_{OL}	—	0.4	V

6 AC Electrical Characteristics

The following sections include illustrations and tables of clock diagrams, signals, and CPM outputs and inputs for 66.67/83.33/100/133 MHz devices. Note that AC timings are based on a 50-pf load for MAX Delay and 10-pf load for MIN delay. Typical output buffer impedances are shown in this table.

Table 9. Output Buffer Impedances¹

Output Buffers	Typical Impedance (Ω)
60x bus	45 or 27 ²
Memory controller	45 or 27 ²
Parallel I/O	45
PCI	27

¹ These are typical values at 65° C. Impedance may vary by $\pm 25\%$ with process and temperature.

² Impedance value is selected through SIUMCR[20,21]. See the SoC reference manual.

6.1 CPM AC Characteristics

This table lists CPM output characteristics.

Table 10. AC Characteristics for CPM Outputs¹

Spec Number		Characteristic	Value (ns)							
Max	Min		Maximum Delay				Minimum Delay			
			66 MHz	83 MHz	100 MHz	133 MHz	66 MHz	83 MHz	100 MHz	133 MHz
sp36a	sp37a	FCC outputs—internal clock (NMSI)	6	5.5	5.5	5.5	0.5	0.5	0.5	0.5
sp36b	sp37b	FCC outputs—external clock (NMSI)	8	8	8	8	2	2	2	2
sp38a	sp39a	SCC/SMC/SPI/I2C outputs—internal clock (NMSI)	10	10	10	10	0	0	0	0
sp38b	sp39b	SCC/SMC/SPI/I2C outputs—external clock (NMSI)	8	8	8	8	2	2	2	2
sp40	sp41	TDM outputs/SI	11	11	11	11	2.5	2.5	2.5	2.5
sp42	sp43	TIMER/IDMA outputs	11	11	11	11	0.5	0.5	0.5	0.5
sp42a	sp43a	PIO outputs	11	11	11	11	0.5	0.5	0.5	0.5

¹ Output specifications are measured from the 50% level of the rising edge of CLKIN to the 50% level of the signal. Timings are measured at the pin.

NOTE: Conditions

The following conditions must be met in order to operate the MPC8272 family devices with 133 MHz bus: single PowerQUICC II Bus mode must be used (no external master, BCR[EBM] = 0); data bus must be in Pipeline mode (BRx[DR] = 1); internal arbiter and memory controller must be used. For expected load of above 40 pF, it is recommended that data and address buses be configured to low (25 Ω) impedance (SIUMCR[HLBE0] = 1, SIUMCR[HLBE1] = 1).

Table 12. AC Characteristics for SIU Inputs¹

Spec Number		Characteristic	Value (ns)							
Setup	Hold		Setup				Hold			
			66 MHz	83 MHz	100 MHz	133 MHz	66 MHz	83 MHz	100 MHz	133 MHz
sp11	sp10	AACK/TA/TS/DBG/BG/BR/ARTRY/TEA	6	5	3.5	N/A	0.5	0.5	0.5	N/A
sp12	sp10	Data bus in normal mode	5	4	3.5	N/A	0.5	0.5	0.5	N/A
sp13	sp10	Data bus in pipeline mode (without ECC and PARITY)	N/A	4	2.5	1.5	N/A	0.5	0.5	0.5
sp15	sp10	All other pins	5	4	3.5	N/A	0.5	0.5	0.5	N/A

¹ Input specifications are measured from the 50% level of the signal to the 50% level of the rising edge of CLKIN. Timings are measured at the pin.

This table lists SIU output characteristics.

Table 13. AC Characteristics for SIU Outputs¹

Spec Number		Characteristic	Value (ns)							
Max	Min		Maximum Delay				Minimum Delay			
			66 MHz	83 MHz	100 MHz	133 MHz	66 MHz	83 MHz	100 MHz	133 MHz
sp31	sp30	PSDVAL/TEA/TA	7	6	5.5	N/A	1	1	1	N/A
sp32	sp30	ADD/ADD_atr./BADDR/CI/GBL/WT	8	6.5	5.5	4.5 ²	1	1	1	1 ²
sp33	sp30	Data bus ³	6.5	6.5	5.5	4.5	0.8	0.8	0.8	1
sp34	sp30	Memory controller signals/ALE	6	5.5	5.5	4.5	1	1	1	1
sp35	sp30	All other signals	6	5.5	5.5	N/A	1	1	1	N/A

¹ Output specifications are measured from the 50% level of the rising edge of CLKIN to the 50% level of the signal. Timings are measured at the pin.

² Value is for ADD only; other sp32/sp30 signals are not applicable.

³ To achieve 1 ns of hold time at 66.67/83.33/100 MHz, a minimum loading of 20 pF is required.

7 Clock Configuration Modes

As shown in this table, the clocking mode is set according to two sources:

- PCI_CFG[0]— An input signal. Also defined as “PCI_HOST_EN.” See Chapter 6, “External Signals,” and Chapter 9, “PCI Bridge,” in the SoC reference manual.
- PCI_MODCK—Bit 27 in the Hard Reset Configuration Word. See Chapter 5, “Reset,” in the SoC reference manual.

Table 16. SoC Clocking Modes

Pins		Clocking Mode	PCI Clock Frequency Range (MHz)	Reference
PCI_CFG[0] ¹	PCI_MODCK ²			
0	0	PCI host	50–66	Table 17
0	1		25–50	Table 18
1	0	PCI agent	50–66	Table 19
1	1		25–50	Table 20

¹ PCI_HOST_EN

² Determines PCI clock frequency range.

Within each mode, the configuration of bus, core, PCI, and CPM frequencies is determined by seven bits during the power-on reset—three hardware configuration pins (MODCK[1–3]) and four bits from hardware configuration word[28–31] (MODCK_H). Both the PLLs and the dividers are set according to the selected clock operation mode as described in the following sections.

NOTE

Clock configurations change only after $\overline{\text{PORESET}}$ is asserted.

NOTE: Tval (Output Hold)

The minimum Tval = 2 ns when PCI_MODCK = 1, and the minimum Tval = 1 ns when PCI_MODCK = 0. Therefore, designers should use clock configurations that fit this condition to achieve PCI-compliant AC timing.

7.1 PCI Host Mode

These tables show configurations for PCI host mode. The frequency values listed are for the purpose of illustration only. Users must select a mode and input bus frequency so that the resulting configuration does not exceed the frequency rating of the user’s device. Note that in PCI host mode the input clock is the bus clock.

Table 18. Clock Configurations for PCI Host Mode (PCI_MODCK=1)^{1,2}

Mode ³	Bus Clock (MHz)		CPM Multiplication Factor ⁴	CPM Clock (MHz)		CPU Multiplication Factor ⁵	CPU Clock (MHz)		PCI Division Factor ⁶	PCI Clock (MHz)	
MODCK_H- MODCK[1-3]	Low	High		Low	High		Low	High		Low	High
Default Modes (MODCK_H=0000)											
0000_000	60.0	100.0	2	120.0	200.0	2.5	150.0	250.0	4	30.0	50.0
0000_001	50.0	100.0	2	100.0	200.0	3	150.0	300.0	4	25.0	50.0
0000_010	60.0	120.0	2.5	150.0	300.0	3	180.0	360.0	6	25.0	50.0
0000_011	60.0	120.0	2.5	150.0	300.0	3.5	210.0	420.0	6	25.0	50.0
0000_100	60.0	120.0	2.5	150.0	300.0	4	240.0	480.0	6	25.0	50.0
0000_101	50.0	100.0	3	150.0	300.0	3	150.0	300.0	6	25.0	50.0
0000_110	50.0	100.0	3	150.0	300.0	3.5	175.0	350.0	6	25.0	50.0
0000_111	50.0	100.0	3	150.0	300.0	4	200.0	400.0	6	25.0	50.0
Full Configuration Modes											
0001_000	50.0	100.0	3	150.0	300.0	5	250.0	500.0	6	25.0	50.0
0001_001	50.0	100.0	3	150.0	300.0	6	300.0	600.0	6	25.0	50.0
0001_010	50.0	100.0	3	150.0	300.0	7	350.0	700.0	6	25.0	50.0
0001_011	50.0	100.0	3	150.0	300.0	8	400.0	800.0	6	25.0	50.0
0010_000	50.0	100.0	4	200.0	400.0	5	250.0	500.0	8	25.0	50.0
0010_001	50.0	100.0	4	200.0	400.0	6	300.0	600.0	8	25.0	50.0
0010_010	50.0	100.0	4	200.0	400.0	7	350.0	700.0	8	25.0	50.0
0010_011	50.0	100.0	4	200.0	400.0	8	400.0	800.0	8	25.0	50.0
0010_100	37.5	75.0	4	150.0	300.0	5	187.5	375.0	6	25.0	50.0
0010_101	37.5	75.0	4	150.0	300.0	5.5	206.3	412.5	6	25.0	50.0
0010_110	37.5	75.0	4	150.0	300.0	6	225.0	450.0	6	25.0	50.0
0011_000	30.0	50.0	5	150.0	250.0	5	150.0	250.0	5	30.0	50.0
0011_001	25.0	50.0	5	125.0	250.0	6	150.0	300.0	5	25.0	50.0
0011_010	25.0	50.0	5	125.0	250.0	7	175.0	350.0	5	25.0	50.0
0011_011	25.0	50.0	5	125.0	250.0	8	200.0	400.0	5	25.0	50.0
0100_000	Reserved										

Table 18. Clock Configurations for PCI Host Mode (PCI_MODCK=1)^{1,2} (continued)

Mode ³	Bus Clock (MHz)		CPM Multiplication Factor ⁴	CPM Clock (MHz)		CPU Multiplication Factor ⁵	CPU Clock (MHz)		PCI Division Factor ⁶	PCI Clock (MHz)	
	Low	High		Low	High		Low	High		Low	High
0100_001	25.0	50.0	6	150.0	300.0	6	150.0	300.0	6	25.0	50.0
0100_010	25.0	50.0	6	150.0	300.0	7	175.0	350.0	6	25.0	50.0
0100_011	25.0	50.0	6	150.0	300.0	8	200.0	400.0	6	25.0	50.0
0101_000	60.0	100.0	2	120.0	200.0	2.5	150.0	250.0	4	30.0	50.0
0101_001	50.0	100.0	2	100.0	200.0	3	150.0	300.0	4	25.0	50.0
0101_010	50.0	100.0	2	100.0	200.0	3.5	175.0	350.0	4	25.0	50.0
0101_011	50.0	100.0	2	100.0	200.0	4	200.0	400.0	4	25.0	50.0
0101_100	50.0	100.0	2	100.0	200.0	4.5	225.0	450.0	4	25.0	50.0
0101_101	42.9	83.3	3	128.6	250.0	3.5	150.0	291.7	5	25.7	50.0
0101_110	41.7	83.3	3	125.0	250.0	4	166.7	333.3	5	25.0	50.0
0101_111	41.7	83.3	3	125.0	250.0	4.5	187.5	375.0	5	25.0	50.0
0110_000	60.0	120.0	2.5	150.0	300.0	2.5	150.0	300.0	6	25.0	50.0
0110_001	60.0	120.0	2.5	150.0	300.0	3	180.0	360.0	6	25.0	50.0
0110_010	60.0	120.0	2.5	150.0	300.0	3.5	210.0	420.0	6	25.0	50.0
0110_011	60.0	120.0	2.5	150.0	300.0	4	240.0	480.0	6	25.0	50.0
0110_100	60.0	120.0	2.5	150.0	300.0	4.5	270.0	540.0	6	25.0	50.0
0110_101	60.0	120.0	2.5	150.0	300.0	5	300.0	600.0	6	25.0	50.0
0110_110	60.0	120.0	2.5	150.0	300.0	6	360.0	720.0	6	25.0	50.0
0111_000	Reserved										
0111_001	50.0	100.0	3	150.0	300.0	3	150.0	300.0	6	25.0	50.0
0111_010	50.0	100.0	3	150.0	300.0	3.5	175.0	350.0	6	25.0	50.0
0111_011	50.0	100.0	3	150.0	300.0	4	200.0	400.0	6	25.0	50.0
0111_100	50.0	100.0	3	150.0	300.0	4.5	225.0	450.0	6	25.0	50.0
1000_000	Reserved										
1000_001	66.7	133.3	3	200.0	400.0	3	200.0	400.0	8	25.0	50.0

Table 18. Clock Configurations for PCI Host Mode (PCI_MODCK=1)^{1,2} (continued)

Mode ³	Bus Clock (MHz)		CPM Multiplication Factor ⁴	CPM Clock (MHz)		CPU Multiplication Factor ⁵	CPU Clock (MHz)		PCI Division Factor ⁶	PCI Clock (MHz)	
	Low	High		Low	High		Low	High		Low	High
1000_010	66.7	133.3	3	200.0	400.0	3.5	233.3	466.7	8	25.0	50.0
1000_011	66.7	133.3	3	200.0	400.0	4	266.7	533.3	8	25.0	50.0
1000_100	66.7	133.3	3	200.0	400.0	4.5	300.0	600.0	8	25.0	50.0
1000_101	66.7	133.3	3	200.0	400.0	6	400.0	800.0	8	25.0	50.0
1000_110	66.7	133.3	3	200.0	400.0	6.5	433.3	866.7	8	25.0	50.0
1001_000	Reserved										
1001_001	Reserved										
1001_010	57.1	114.3	3.5	200.0	400.0	3.5	200.0	400.0	8	25.0	50.0
1001_011	57.1	114.3	3.5	200.0	400.0	4	228.6	457.1	8	25.0	50.0
1001_100	57.1	114.3	3.5	200.0	400.0	4.5	257.1	514.3	8	25.0	50.0
1001_101	42.9	85.7	3.5	150.0	300.0	5	214.3	428.6	6	25.0	50.0
1001_110	42.9	85.7	3.5	150.0	300.0	5.5	235.7	471.4	6	25.0	50.0
1001_111	42.9	85.7	3.5	150.0	300.0	6	257.1	514.3	6	25.0	50.0
1010_000	75.0	150.0	2	150.0	300.0	2	150.0	300.0	6	25.0	50.0
1010_001	75.0	150.0	2	150.0	300.0	2.5	187.5	375.0	6	25.0	50.0
1010_010	75.0	150.0	2	150.0	300.0	3	225.0	450.0	6	25.0	50.0
1010_011	75.0	150.0	2	150.0	300.0	3.5	262.5	525.0	6	25.0	50.0
1010_100	75.0	150.0	2	150.0	300.0	4	300.0	600.0	6	25.0	50.0
1010_101	100.0	200.0	2	200.0	400.0	2.5	250.0	500.0	8	25.0	50.0
1010_110	100.0	200.0	2	200.0	400.0	3	300.0	600.0	8	25.0	50.0
1010_111	100.0	200.0	2	200.0	400.0	3.5	350.0	700.0	8	25.0	50.0
1011_000	Reserved										
1011_001	80.0	160.0	2.5	200.0	400.0	2.5	200.0	400.0	8	25.0	50.0
1011_010	80.0	160.0	2.5	200.0	400.0	3	240.0	480.0	8	25.0	50.0
1011_011	80.0	160.0	2.5	200.0	400.0	3.5	280.0	560.0	8	25.0	50.0
1011_100	80.0	160.0	2.5	200.0	400.0	4	320.0	640.0	8	25.0	50.0

- ⁶ CPM_CLK/PCI_CLK ratio. When PCI_MODCK = 1, the ratio of CPM_CLK/PCI_CLK should be calculated from PCIDF as follows:
- PCIDF = 3 > CPM_CLK/PCI_CLK = 4
 - PCIDF = 5 > CPM_CLK/PCI_CLK = 6
 - PCIDF = 7 > CPM_CLK/PCI_CLK = 8
 - PCIDF = 9 > CPM_CLK/PCI_CLK = 5
 - PCIDF = B > CPM_CLK/PCI_CLK = 6

7.2 PCI Agent Mode

These tables show configurations for PCI agent mode. The frequency values listed are for the purpose of illustration only. Users must select a mode and input bus frequency so that the resulting configuration does not exceed the frequency rating of the user's device. Note that in PCI agent mode the input clock is PCI clock.

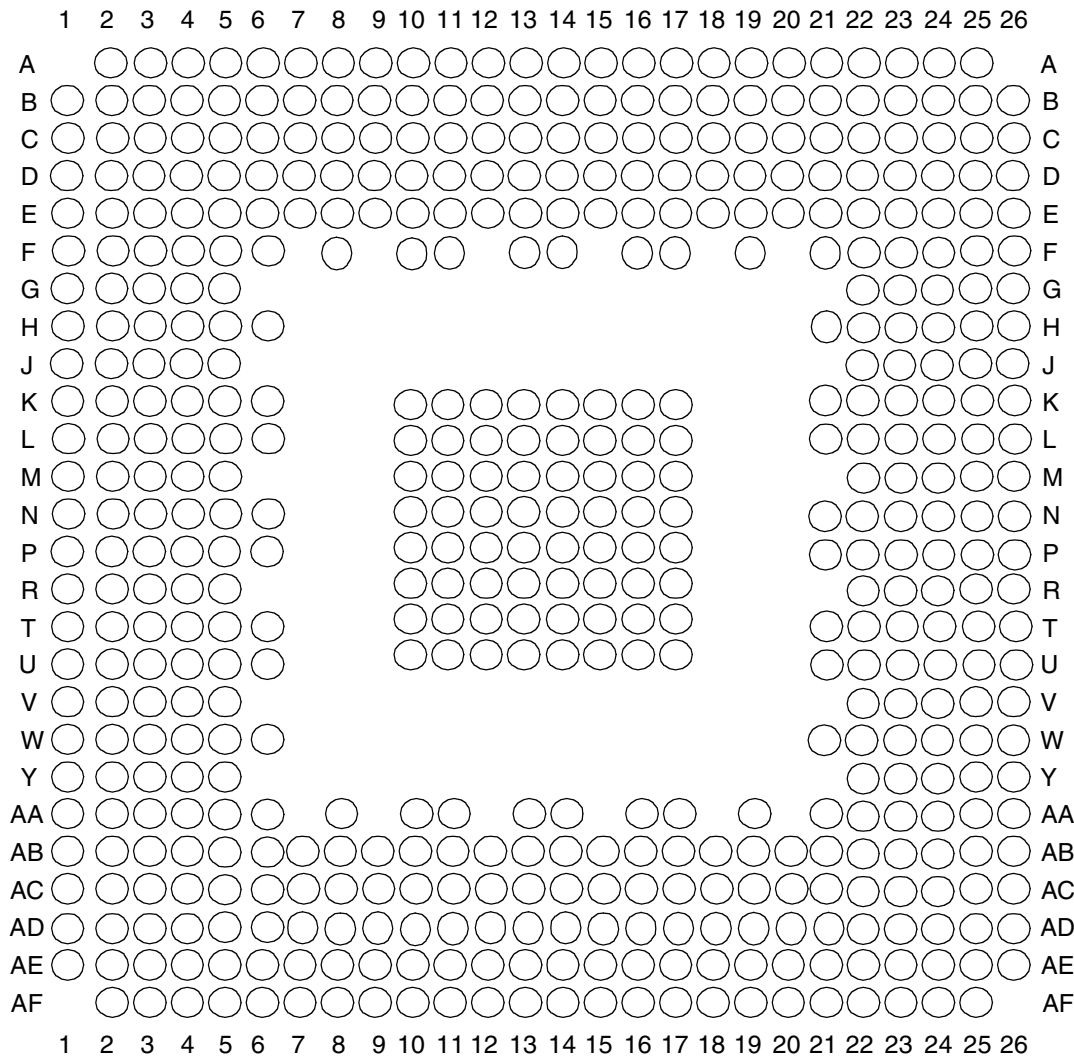
Table 19. Clock Configurations for PCI Agent Mode (PCI_MODCK=0)^{1,2}

Mode ³	PCI Clock (MHz)		CPM Multiplication Factor ⁴	CPM Clock (MHz)		CPU Multiplication Factor ⁵	CPU Clock (MHz)		Bus Division Factor	Bus Clock (MHz)	
MODCK_H- MODCK[1-3]	Low	High		Low	High		Low	High		Low	High
Default Modes (MODCK_H=0000)											
0000_000	60.0	66.7	2	120.0	133.3	2.5	150.0	166.7	2	60.0	66.7
0000_001	50.0	66.7	2	100.0	133.3	3	150.0	200.0	2	50.0	66.7
0000_010	50.0	66.7	3	150.0	200.0	3	150.0	200.0	3	50.0	66.7
0000_011	50.0	66.7	3	150.0	200.0	4	200.0	266.6	3	50.0	66.7
0000_100	50.0	66.7	3	150.0	200.0	3	180.0	240.0	2.5	60.0	80.0
0000_101	50.0	66.7	3	150.0	200.0	3.5	210.0	280.0	2.5	60.0	80.0
0000_110	50.0	66.7	4	200.0	266.6	3.5	233.3	311.1	3	66.7	88.9
0000_111	50.0	66.7	4	200.0	266.6	3	240.0	320.0	2.5	80.0	106.7
Full Configuration Modes											
0001_001	60.0	66.7	2	120.0	133.3	5	150.0	166.7	4	30.0	33.3
0001_010	50.0	66.7	2	100.0	133.3	6	150.0	200.0	4	25.0	33.3
0001_011	50.0	66.7	2	100.0	133.3	7	175.0	233.3	4	25.0	33.3
0001_100	50.0	66.7	2	100.0	133.3	8	200.0	266.6	4	25.0	33.3
0010_001	50.0	66.7	3	150.0	200.0	3	180.0	240.0	2.5	60.0	80.0
0010_010	50.0	66.7	3	150.0	200.0	3.5	210.0	280.0	2.5	60.0	80.0
0010_011	50.0	66.7	3	150.0	200.0	4	240.0	320.0	2.5	60.0	80.0
0010_100	50.0	66.7	3	150.0	200.0	4.5	270.0	360.0	2.5	60.0	80.0

Table 20. Clock Configurations for PCI Agent Mode (PCI_MODCK=1)^{1,2}

Mode ³	PCI Clock (MHz)		CPM Multiplication Factor ⁴	CPM Clock (MHz)		CPU Multiplication Factor ⁵	CPU Clock (MHz)		Bus Division Factor	Bus Clock (MHz)	
MODCK_H- MODCK[1-3]	Low	High		Low	High		Low	High		Low	High
Default Modes (MODCK_H=0000)											
0000_000	30.0	50.0	4	120.0	200.0	2.5	150.0	250.0	2	60.0	100.0
0000_001	25.0	50.0	4	100.0	200.0	3	150.0	300.0	2	50.0	100.0
0000_010	25.0	50.0	6	150.0	300.0	3	150.0	300.0	3	50.0	100.0
0000_011	25.0	50.0	6	150.0	300.0	4	200.0	400.0	3	50.0	100.0
0000_100	25.0	50.0	6	150.0	300.0	3	180.0	360.0	2.5	60.0	120.0
0000_101	25.0	50.0	6	150.0	300.0	3.5	210.0	420.0	2.5	60.0	120.0
0000_110	25.0	50.0	8	200.0	400.0	3.5	233.3	466.7	3	66.7	133.3
0000_111	25.0	50.0	8	200.0	400.0	3	240.0	480.0	2.5	80.0	160.0
Full Configuration Modes											
0001_001	30.0	50.0	4	120.0	200.0	5	150.0	250.0	4	30.0	50.0
0001_010	25.0	50.0	4	100.0	200.0	6	150.0	300.0	4	25.0	50.0
0001_011	25.0	50.0	4	100.0	200.0	7	175.0	350.0	4	25.0	50.0
0001_100	25.0	50.0	4	100.0	200.0	8	200.0	400.0	4	25.0	50.0
0010_001	25.0	50.0	6	150.0	300.0	3	180.0	360.0	2.5	60.0	120.0
0010_010	25.0	50.0	6	150.0	300.0	3.5	210.0	420.0	2.5	60.0	120.0
0010_011	25.0	50.0	6	150.0	300.0	4	240.0	480.0	2.5	60.0	120.0
0010_100	25.0	50.0	6	150.0	300.0	4.5	270.0	540.0	2.5	60.0	120.0
0011_000	Reserved										
0011_001	37.5	50.0	4	150.0	200.0	3	150.0	200.0	3	50.0	66.7
0011_010	32.1	50.0	4	128.6	200.0	3.5	150.0	233.3	3	42.9	66.7
0011_011	28.1	50.0	4	112.5	200.0	4	150.0	266.7	3	37.5	66.7
0011_100	25.0	50.0	4	100.0	200.0	4.5	150.0	300.0	3	33.3	66.7
0100_000	Reserved										
0100_001	25.0	50.0	6	150.0	300.0	3	150.0	300.0	3	50.0	100.0
0100_010	25.0	50.0	6	150.0	300.0	3.5	175.0	350.0	3	50.0	100.0
0100_011	25.0	50.0	6	150.0	300.0	4	200.0	400.0	3	50.0	100.0

This figure shows the pinout of the 516 PBGA package as viewed from the top surface.



Not to Scale

Figure 12. Pinout of the 516 PBGA Package (View from Top)

This table lists the pins of the MPC8272. Note that the pins in the “MPC8272/8271 Only” column relate to Utopia functionality.

Table 21. Pinout

Pin Name		Ball
MPC8272/MPC8248 and MPC8271/MPC8247	MPC8272/MPC8271 Only	
$\overline{\text{BR}}$		A19
$\overline{\text{BG}}/\text{IRQ6}$		D2
$\overline{\text{ABB}}/\text{IRQ2}$		C1

Table 21. Pinout (continued)

Pin Name		Ball
MPC8272/MPC8248 and MPC8271/MPC8247	MPC8272/MPC8271 Only	
D46		H4
D47		F2
D48		AB1
D49		U4
D50		U1
D51		R3
D52		N3
D53		K2
D54		H5
D55		F4
D56		AA3
D57		U5
D58		U2
D59		P5
D60		M3
D61		K4
D62		H3
D63		E1
IRQ3/CKSTP_OUT/EXT_BR3		B16
IRQ4/CORE_SRESET/EXT_BG3		C15
IRQ5/TBEN/EXT_DBG3/CINT		Y4
PSDVAL		C19
TA		AA4
TEA		AB6
GBL/IRQ1		D15
CI/BADDR29/IRQ2		D16
WT/BADDR30/IRQ3		C16
BADDR31/IRQ5/CINT		E17
CPU_BR/INT_OUT		B20
CS0		AE6
CS1		AD7

Table 21. Pinout (continued)

Pin Name		Ball
MPC8272/MPC8248 and MPC8271/MPC8247	MPC8272/MPC8271 Only	
MODCK1/ $\overline{\text{RSRV}}$ /TC0/BNKSEL0		A20
MODCK2/CSE0/TC1/BNKSEL1		C20
MODCK3/CSE1/TC2/BNKSEL2		A21
CLKIN1		D21
PA8/SMRXD2		AF25 ³
PA9/SMTXD2		AA22 ³
PA10/MSNUM5	FCC1_UT_RXD0	AB23 ³
PA11/MSNUM4	FCC1_UT_RXD1	AD26 ³
PA12/MSNUM3	FCC1_UT_RXD2	AD25 ³
PA13/MSNUM2	FCC1_UT_RXD3	AA24 ³
PA14/FCC1_MII_HDLC_RXD3	FCC1_UT_RXD4	W22 ³
PA15/FCC1_MII_HDLC_RXD2	FCC1_UT_RXD5	Y24 ³
PA16/FCC1_MII_HDLC_RXD1	FCC1_UT_RXD6	T22 ³
PA17/FCC1_MII_HDLC_RXD0/ FCC1_MII_TRAN_RXD/FCC1_RMII_RX D0	FCC1_UT_RXD7	W26 ³
PA18/FCC1_MII_HDLC_TXD0/FCC1_MII _TRAN_TXD/ FCC1_RMII_TXD0	FCC1_UT_TXD7	V26 ³
PA19/FCC1_MII_HDLC_TXD1/FCC1_RM II_TXD1	FCC1_UT_TXD6	R23 ³
PA20/FCC1_MII_HDLC_TXD2	FCC1_UT_TXD5	P25 ³
PA21/FCC1_MII_HDLC_TXD3	FCC1_UT_TXD4	N22 ³
PA22	FCC1_UT_TXD3	N26 ³
PA23	FCC1_UT_TXD2	N23 ³
PA24/MSNUM1	FCC1_UT_TXD1	H26 ³
PA25/MSNUM0	FCC1_UT_TXD0	G25 ³
PA26/FCC1_MII_RMII_RX_ER	FCC1_UT_RXCLAV	L22 ³
PA27/FCC1_MII_RX_DV/FCC1_RMII_CR S_DV	FCC1_UT_RXSOC	G24 ³
PA28/FCC1_MII_RMII_TX_EN	FCC1_UT_RXENB	G23 ³
PA29/FCC1_MII_TX_ER	$\overline{\text{FCC1_UT_TXSOC}}$	B26 ³
PA30/FCC1_MII_CRS/ $\overline{\text{FCC1_RTS}}$	FCC1_UT_TXCLAV	A25 ³

Table 21. Pinout (continued)

Pin Name		Ball
MPC8272/MPC8248 and MPC8271/MPC8247	MPC8272/MPC8271 Only	
PA31/FCC1_MII_COL	$\overline{\text{FCC1_UT_TXENB}}$	G22 ³
PB18/FCC2_MII_HDLC_RXD3		T25 ³
PB19/FCC2_MII_HDLC_RXD2		P22 ³
PB20/FCC2_MII_HDLC_RMII_RXD1		L25 ³
PB21/FCC2_MII_HDLC_RMII_RXD0/FCC2_TRAN_RXD		J26 ³
PB22/FCC2_MII_HDLC_TXD0/FCC2_TRAN_TXD/ FCC2_RMII_TXD0		U23 ³
PB23/FCC2_MII_HDLC_TXD1/FCC2_RMII_TXD1		U26 ³
PB24/FCC2_MII_HDLC_TXD2/L1RSYNCB2		M24 ³
PB25/FCC2_MII_HDLC_TXD3/L1TSYNCB2		M23 ³
PB26/FCC2_MII_CRS/L1RXDB2		H24 ³
PB27/FCC2_MII_COL/L1TXDB2		E25 ³
PB28/FCC2_MII_RMII_RX_ER/ $\overline{\text{FCC2_RTS}}$ /TXD1		D26 ³
PB29/FCC2_MII_RMII_TX_EN		K21 ³
PB30/FCC2_MII_RX_DV/FCC2_RMII_CRS_DV		D24 ³
PB31/FCC2_MII_TX_ER		E23 ³
PC0/ $\overline{\text{DREQ3}}$ /BRGO7/ $\overline{\text{SMSYN1}}$ /L1CLKOA2		AF23 ³
PC1/BRGO6/ $\overline{\text{L1RQA2}}$		AD23 ³
PC4/SMRXD1/SI2_L1ST4/ $\overline{\text{FCC2_CD}}$		AB22 ³
PC5/SMTXD1/SI2_L1ST3/ $\overline{\text{FCC2_CTS}}$		AE24 ³
PC6/ $\overline{\text{FCC1_CD}}$ /SI2_L1ST2	FCC1_UT_RXADDR2	AF24 ³
PC7/ $\overline{\text{FCC1_CTS}}$	FCC1_UT_TXADDR2	AE26 ³
PC8/ $\overline{\text{CD4}}$ /RTS1/SI2_L1ST2/ $\overline{\text{CTS3}}$		AC24 ³
PC9/ $\overline{\text{CTS4}}$ /L1TSYNCA2		AA23 ³
PC10/ $\overline{\text{CD3}}$ /USB_RN		AB25 ³
PC11/ $\overline{\text{CTS3}}$ /USB_RP/L1TXD3A2		V22 ³
PC12	FCC1_UT_RXADDR1	AA26 ³
PC13/BRGO5	FCC1_UT_TXADDR1	V23 ³
PC14/ $\overline{\text{CD1}}$	FCC1_UT_RXADDR0	W24 ³
PC15/ $\overline{\text{CTS1}}$	FCC1_UT_TXADDR0	U24 ³
PC16/CLK16		T23 ³

Table 21. Pinout (continued)

Pin Name		Ball
MPC8272/MPC8248 and MPC8271/MPC8247	MPC8272/MPC8271 Only	
PC17/CLK15/BRGO8/ $\overline{\text{DONE2}}$		T26 ³
PC18/CLK14/ $\overline{\text{TGATE2}}$		R26 ³
PC19/CLK13/BRGO7/ $\overline{\text{TGATE1}}$		P24 ³
PC20/CLK12/ $\overline{\text{USB0E}}$		L26 ³
PC21/CLK11/BRGO6/CP_INT		L24 ³
PC22/CLK10/ $\overline{\text{DONE3}}$	FCC1_UT_TXPRTY	L23 ³
PC23/CLK9/BRGO5/ $\overline{\text{DACK3}}$ / $\overline{\text{CD1}}$		K24 ³
PC24/CLK8/TIN3/ $\overline{\text{TOUT4}}$ /DREQ2/BRGO1		K23 ³
PC25/CLK7/BRGO4/ $\overline{\text{DACK2}}$ /SPISEL		F26 ³
PC26/CLK6/ $\overline{\text{TOUT3}}$ /TMCLK		H23 ³
PC27/CLK5/BRGO3/ $\overline{\text{TOUT1}}$	FCC1_UT_RXPRTY	K22 ³
PC28/CLK4/TIN1/ $\overline{\text{TOUT2}}$ /SPICLK		D25 ³
PC29/CLK3/TIN2/BRGO2/ $\overline{\text{CTS1}}$		F24 ³
PD7/SMSYN2	FCC1_UT_TXADDR3	AB21 ³
PD14/I2CSCL		AC26 ³
PD15/I2CSDA		Y23 ³
PD16/SPIMISO	FCC1_UT_TXPRTY	AA25 ³
PD17/BRGO2/SPIMOSI	FCC1_UT_RXPRTY	Y26 ³
PD18/SPICLK	FCC1_UT_RXADDR4	W25 ³
PD19/SPISEL/BRGO1	FCC1_UT_TXADDR4	V25 ³
PD20/ $\overline{\text{RTS4}}$ /L1RSYNCA2		R24 ³
PD21/TXD4/L1RXD0A2		P23 ³
PD22/RXD4/L1TXD0A2		N25 ³
PD23/ $\overline{\text{RTS3}}$ /USB_TP		K26 ³
PD24/TXD3/USB_TN		K25 ³
PD25/RXD3/USB_RXD		J25 ³
PD29/ $\overline{\text{RTS1}}$	FCC1_UT_RXADDR3	C26 ³
PD30/TXD1		E24 ³
PD31/RXD1		B25 ³
VCCSYN		C18
VCCSYN1		K6

10 Ordering Information

This figure provides an example of the Freescale part numbering nomenclature for the SoC. In addition to the processor frequency, the part numbering scheme also consists of a part modifier that indicates any enhancement(s) in the part from the original production design. Each part number also contains a revision code that refers to the die mask revision number and is specified in the part numbering scheme for identification purposes only. For more information, contact your local Freescale sales office.

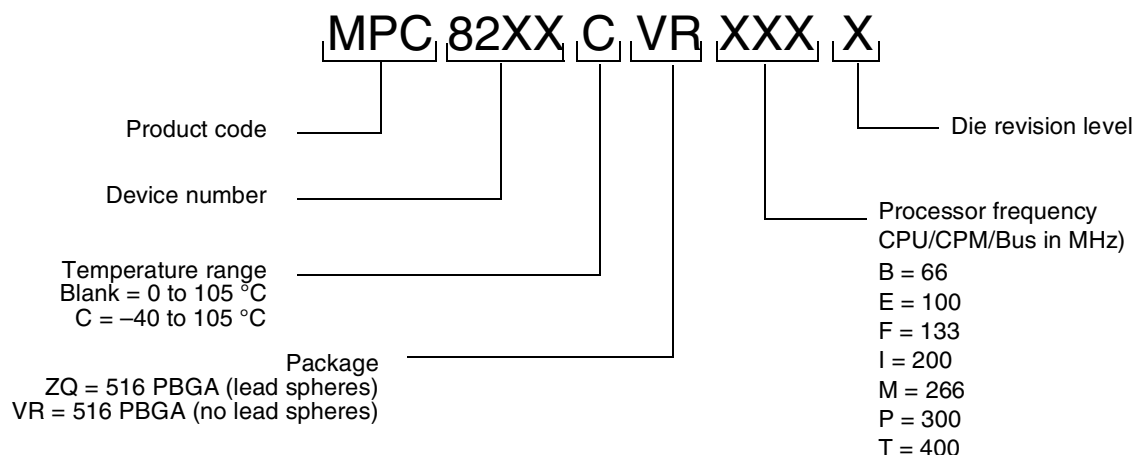


Figure 15. Freescale Part Number Key

11 Document Revision History

This table summarizes changes to this document.

Table 23. Document Revision History

Revision	Date	Substantive Changes
3	09/2011	In Figure 15 , "Freescale Part Number Key," added speed decoding information below processor frequency information.
2	12/2008	- Modified Figure 5, "SCC/SMC/SPI/I2C External Clock Diagram," and added second section of figure notes. - In Table 12, modified "Data bus in pipeline mode" row and showed 66 MHz as "N/A." - In Section 10, "Ordering Information," added "F = 133" to CPU/CPM/Bus Frequency. - Added footnote concerning CPM_CLK/PCI_CLK ratio to column "PCI Division Factor" in Table 17, "Clock Configurations for PCI Host Mode (PCI_MODCK=0)," and Table 18, "Clock Configurations for PCI Host Mode (PCI_MODCK=1)." - Removed overbar from DLL_ENABLE in Table 21, "Pinout."
1.5	12/2006	Section 6, "AC Electrical Characteristics," removed deratings statement and clarified AC timing descriptions.
1.4	05/2006	Added row for 133 MHz configurations to Table 8.
1.3	02/2006	Inserted Section 6.3, "JTAG Timings."

Table 23. Document Revision History (continued)

Revision	Date	Substantive Changes
1.2	09/2005	- Added 133-MHz to the list of frequencies in the opening sentence of Section 6, “AC Electrical Characteristics”. - Added 133 MHz columns to Table 9, Table 11, Table 12, and Table 13. - Added footnote 2 to Table 13. - Added the conditions note directly above Table 12.
1.1	01/2005	Modification for correct display of assertion level (“overbar”) for some signals
1.0	12/2004	- Section 1.1: Added 8:1 ratio to Internal CPM/bus clock multiplier values - Section 2: removed voltage tracking note Table 3: Note 2 updated regarding VDD/VCCSYN relationship to VDDH during power-on reset Table 4: Updated VDD and VCCSYN to 1.425 V - 1.575 V Table 8: Note 2 updated to reflect VIH=2.5 for TCK, TRST, PORESET; request for external pull-up removed. - Section 4.6: Updated description of layout practices Table 8: Note 3 added regarding IIC compatibility Table 8: Updated nominal and maximum power dissipation values Table 9: updated PCI impedance to 27Ω, updated 60x and MEMC values and added note to reflect configurable impedance - Section 6: Added sentence providing derating factor - Section 6.1: added Note: Rise/Fall Time on CPM Input Pins Table 9: updated values for following specs: sp36b, sp37a, sp38a, sp39a, sp38b, sp40, sp41, sp42, sp43, sp42a Table 11: updated values for following specs: sp16a, sp16b, sp18a, sp18b, sp20, sp21, sp22 - Section 6.2: added spread spectrum clocking note - Section 6.2: added CLKIN jitter note Table 12: combined specs sp11 and sp11a Table 13: sp30 Data Bus minimum delay values changed to 0.8 - Section 7: unit of ns added to Tval notes - Section 7: Updated all notes to reflect updated CPU Fmin of 150 MHz commercial temp devices, 175 MHz extended temp; CPM Fmin of 120 MHz. Section 7, “Clock Configuration Modes”: Updated all table footnotes reflect updated CPU Fmin of 150 MHz commercial temp devices, 175 MHz extended temp; CPM Fmin of 120 MHz. Table 21: correct superscript of footnote number after pin AD22 Table 21: remove DONE3 from PC12 Table 21: signals referring to TDMs C2 and D2 removed